

# SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

## APPROVAL SHEET

MODEL NO.: SMD0603-020	
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CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

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Submitted by: Approved by: DATE: Jay Chen YC Lin 2014/12/24



## Features

- Surface Mount Devices
- Lead free device
- Size 1.5\*0.8 mm / 0.06\*0.03 inch
- Surface Mount packaging
  - for automated assembly

#### Applications

- Almost anywhere there is a low voltage power supply, up to 15V and a load to be
- protected, including:
- Computer mother board, Modem. USB hub
  PDAs & Charger, Analog & digital line card
- Digital cameras, Disk drivers, CD-ROMs,

## SMD0603-020

## Performance Specification

Model	Marking V <sub>ma</sub>	V <sub>max</sub>	V <sub>max</sub> I <sub>max</sub>	I <sub>hold</sub> I <sub>trip</sub>	$\mathbf{P}_{d}$	Maximum P <sub>d</sub> Time To Trip		Resistance		Agency Approval		
inodei	Marking	(Vdc)	(A)	@25°C (A)	@25°C (A)	Тур. (W)	Current (A)	Time (Sec)	Ri <sub>min</sub> (Ω)	R1max (Ω)	UL	τυν
SMD0603-020	2	9.0	40	0.20	0.50	0.5	1.0	0.60	0.550	3.500	$\checkmark$	
Ihold = Hold Current. Maximum current device will not trip in 25°C still air.												
Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.												
Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).												
Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).												
Pd = Power dissipation	Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.											
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.												
R1 <sub>max</sub> = Maximum devi	ce resistance	e is measured	l one hour p	ost reflow.								
CAUTION : Operation be	eyond the sp	ecified rating	s may result	in damage a	nd possible a	arcing and fl	lame.					

### **Environmental Specifications**

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum aurfage temperature of the device in the trip	and state is 105 °C	

Maximum surface temperature of the device in the tripped state is 125 °C

AGENCY APPROVALS :		E201504(Alpha-Top)/E319079(Sea&Land)
Regulation/Standard:	PROHS	2002/95/EC
	HF	EN14582

## Ihold Versus Temperature

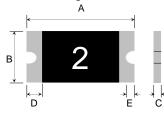
Model	Maximum ambient operating temperature $(T_{mao})$ vs. hold current $(I_{hold})$								
Woder	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD0603-020	0.27	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07

## SMD0603-020

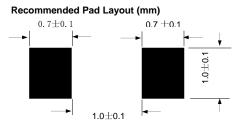
#### **Construction And Dimension (Unit:mm)**

A		Δ		В			D	E	
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	
SMD0603-020	1.45	1.85	0.65	1.05	0.40	1.00	0.15	0.10	

## **Dimensions & Marking**







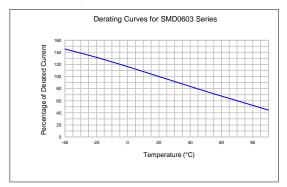
#### **Termination Pad Characteristics**

Terminal pad materials : Terminal pad solderability : Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

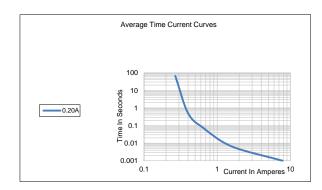
#### Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

#### **Thermal Derating Curve**



#### Typical Time-To-Trip At 25°C



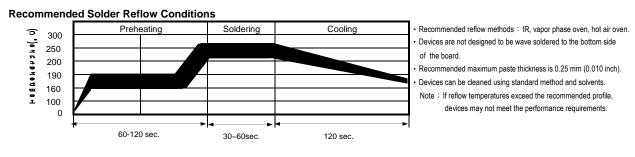
# WARNING:

Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

Use PPTC beyond the maximum ratings or improper use may result in device oamage and possible electrical arcing and flame.
 PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
 Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
 Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/t) above the rated voltage of the PPTC.
 Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
 Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

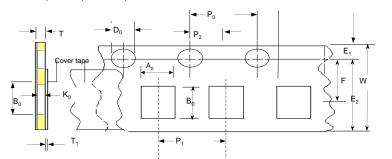
## SMD0603-020



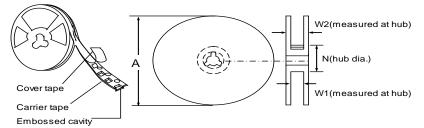
### Tape And Reel Specifications (mm)

### Paper Tape Component Dimensions

Governing Specifications	
W	8.0 ± 0.2
P <sub>0</sub>	4.0 ± 0.10
P <sub>0</sub> P <sub>1</sub> P <sub>2</sub>	$4.0 \pm 0.10$
P <sub>2</sub>	$2.0 \pm 0.05$
A <sub>0</sub>	1.05 ± 0.10
B <sub>0</sub>	1.85 ± 0.10
D <sub>0</sub>	1.55 + 0.05
F E <sub>1</sub>	$3.5 \pm 0.05$
E <sub>1</sub>	1.75 ± 0.10
E <sub>2</sub> min.	6.25
Т	0.75
T <sub>1</sub> max.	0.1
K <sub>0</sub>	0.75/0.95 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W <sub>1</sub>	9.0 ± 0.5
W <sub>2</sub>	12.0 ± 0.05



### **EIA Reel Dimensions**



## Storage And Handling

• Storage conditions : 40°C max, 70% R.H.

· Devices may not meet specified performance

if storage conditions are exceeded.

#### Order Information

Order Information	I	Packaging		
SMD0603	020	Tape & Reel Quantity		
Product name	Hold			
Size 1508 mm / 0603 inch	Current	5,000 pcs/reel		
SMD: surface mount device	0.20A			

Tape & reel packaging per EIA481-1 Labeling Information

